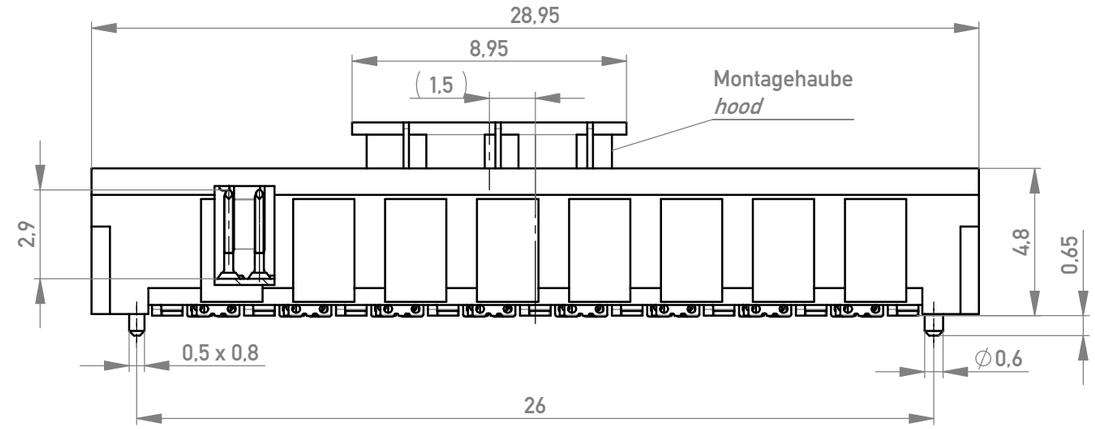
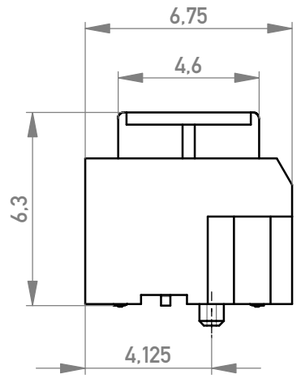
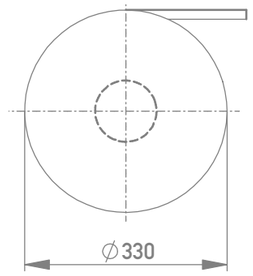
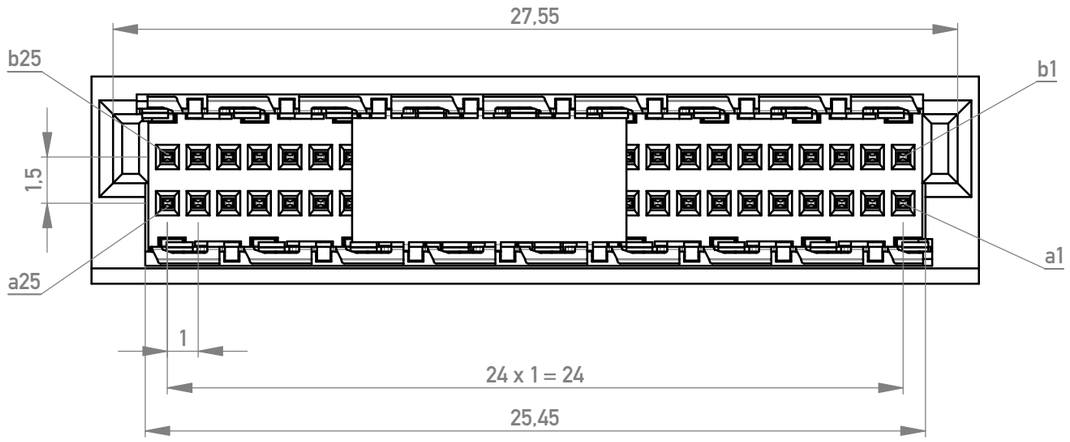


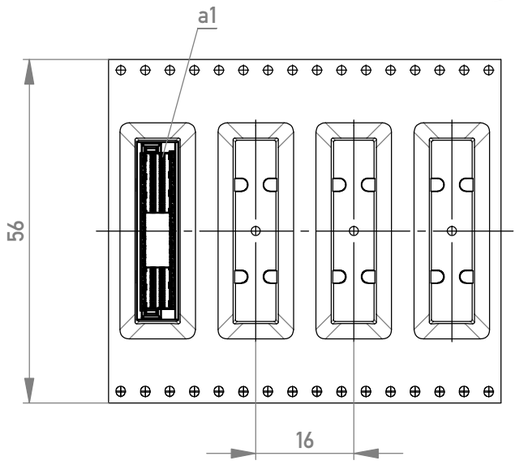


Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 400 Stück
Packaging unit: 400 pcs

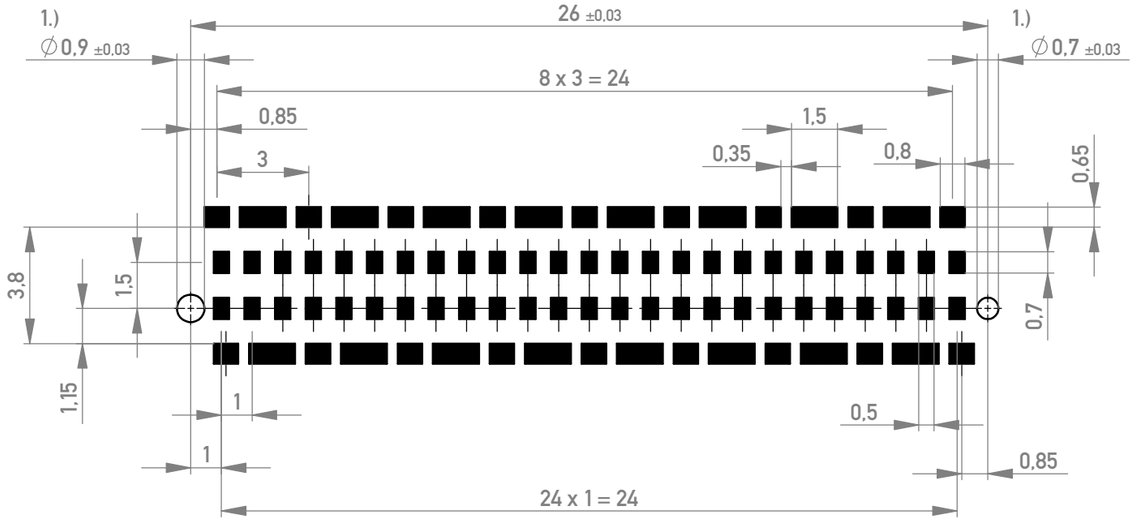




Abspulrichtung - *Reel off Direction*



Leiterplatten-Layout Vorschlag / *PCB-layout proposal*



1.) Durchmesser des Bohrers / *Drill tool*

Für weitere Layout Details bitte Applikations Schrift MicroSpeed beachten.
For further layout details please consider MicroSpeed application note.

Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Information:	Tolerances	All Dimensions in mm	Scale 5:1
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e / 28.01.2014 / Index / Date			374723 | I | A3
			Class MSPEED

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